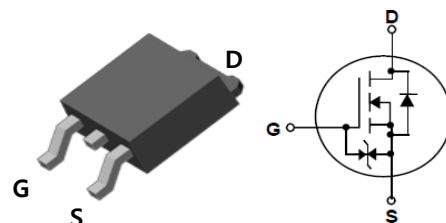


700V N-Channel Super Junction MOSFET

Features

- Very Low FOM ($R_{DS(on)} \times Q_g$)
- Extremely low switching loss
- Built-in ESD Diode
- 100% avalanche tested
- Halogen free and RoHS compliant device

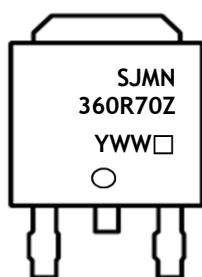


TO-252

Ordering Information

Part Number	Marking	Package
SJMN360R70ZD	SJMN360R70Z	TO-252

Marking Information



Column 1, 2: Device Code
 Column 3: Production Information
 e.g.) YWW□
 -. YWW: Date Code (year, week)
 -. □: Factory Management Code

Absolute maximum ratings ($T_C=25^\circ\text{C}$ unless otherwise noted)

Characteristic	Symbol		Rating	Unit
Drain-source voltage	V _{DSS}		700	V
Gate-source voltage	V _{GSS}		±20	V
Drain current (DC) *	I _D	T _c =25°C	11.6	A
		T _c =100°C	7.3	A
Drain current (Pulsed) *	I _{DM}		35	A
Single pulsed avalanche energy ^(Note 2)	E _{AS}		158	mJ
Repetitive avalanche current ^(Note 1)	I _{AR}		1.85	A
Repetitive avalanche energy ^(Note 1)	E _{AR}		10.6	mJ
Power dissipation	P _D		106	W
Gate to source ESD (Human Body Model)	V _{ESD(G-S)}		2000	V
Junction temperature	T _J		150	°C
Storage temperature range	T _{stg}		-55~150	°C

* Limited only maximum junction temperature

Thermal Characteristics

Characteristic	Symbol	Rating	Unit
Thermal resistance, junction to case	$R_{th(j-c)}$	Max. 1.18	°C/W
Thermal resistance, junction to ambient	$R_{th(j-a)}$	Max. 62.5	

Electrical Characteristics ($T_C=25^{\circ}\text{C}$ unless otherwise noted)

Characteristic	Symbol	Test Condition	Min.	Typ.	Max.	Unit
Drain-source breakdown voltage	BV_{DSS}	$I_D=1\text{mA}$, $V_{GS}=0$	700	-	-	V
Gate threshold voltage	$V_{GS(th)}$	$I_D=440\mu\text{A}$, $V_{DS}=V_{GS}$	2.0	-	4.0	V
Drain-source cut-off current	I_{DSS}	$V_{DS}=700\text{V}$, $V_{GS}=0\text{V}$	-	-	1	μA
		$V_{DS}=700\text{V}$, $T_J=150^{\circ}\text{C}$	-	-	100	μA
Gate leakage current	I_{GSS}	$V_{DS}=0\text{V}$, $V_{GS}=\pm 20\text{V}$	-	-	± 1	μA
Drain-source on-resistance	$R_{DS(ON)}$	$V_{GS}=10\text{V}$, $I_D=3.7\text{A}$	-	0.317	0.36	Ω
Internal gate resistance	R_g	$f=1\text{MHz}$, Open drain	-	2.5	-	Ω
Input capacitance	C_{iss}	$V_{DS}=200\text{V}$, $V_{GS}=0\text{V}$, $f=1\text{MHz}$	-	1156	-	pF
Output capacitance	C_{oss}		-	30	-	
Reverse transfer capacitance	C_{rss}		-	1.4	-	
Turn-on delay time (Note 3, 4)	$t_{d(on)}$	$V_{DS}=350\text{V}$, $I_D=5.7\text{A}$, $R_G=25\Omega$	-	43	-	ns
Rise time (Note 3, 4)	t_r		-	37	-	
Turn-off delay time (Note 3, 4)	$t_{d(off)}$		-	96	-	
Fall time (Note 3, 4)	t_f		-	38	-	
Total gate charge (Note 3, 4)	Q_g	$V_{DS}=560\text{V}$, $V_{GS}=10\text{V}$, $I_D=5.7\text{A}$	-	32	-	nC
Gate-source charge (Note 3, 4)	Q_{gs}		-	10	-	
Gate-drain charge (Note 3, 4)	Q_{gd}		-	10.5	-	

Source-Drain Diode Ratings and Characteristics ($T_C=25^{\circ}\text{C}$ unless otherwise noted)

Characteristic	Symbol	Test Condition	Min.	Typ.	Max.	Unit
Source current (DC)	I_S	Integral reverse diode in the MOSFET	-	-	11.6	A
Source current (Pulsed)	I_{SM}		-	-	35	A
Forward voltage	V_{SD}	$V_{GS}=0\text{V}$, $I_S=5.7\text{A}$	-	-	1.3	V
Reverse recovery time (Note 3, 4)	t_{rr}	$V_R=350\text{V}$, $I_F=5.7\text{A}$ $di_S/dt=-100\text{A}/\mu\text{s}$	-	171	-	ns
Reverse recovery charge (Note 3, 4)	Q_{rr}		-	2.0	-	μC

Note:

1. Repetitive Rating : Pulse width limited by maximum junction temperature
2. $I_{AS}=1.85\text{A}$, $V_{DD}=50\text{V}$, $R_G=25\Omega$, Starting $T_J=25^{\circ}\text{C}$
3. Pulse Test : Pulse width $\leq 300\mu\text{s}$, Duty Cycle $\leq 2\%$
4. Essentially Independent of Operating Temperature

Typical Electrical Characteristics Curves

Fig. 1 $I_D - V_{DS}$

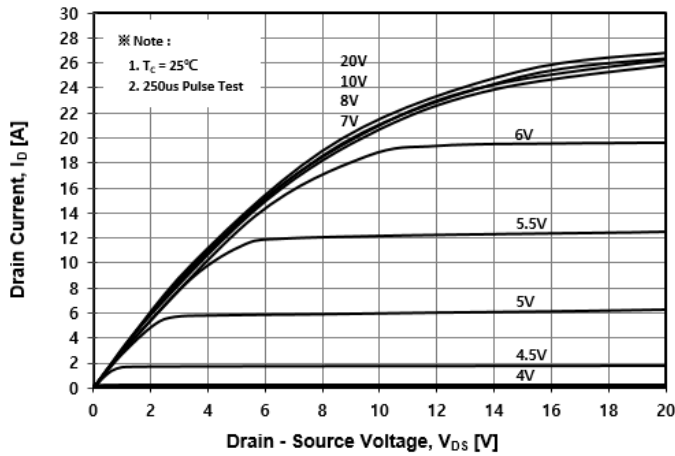


Fig. 2 $I_D - V_{GS}$

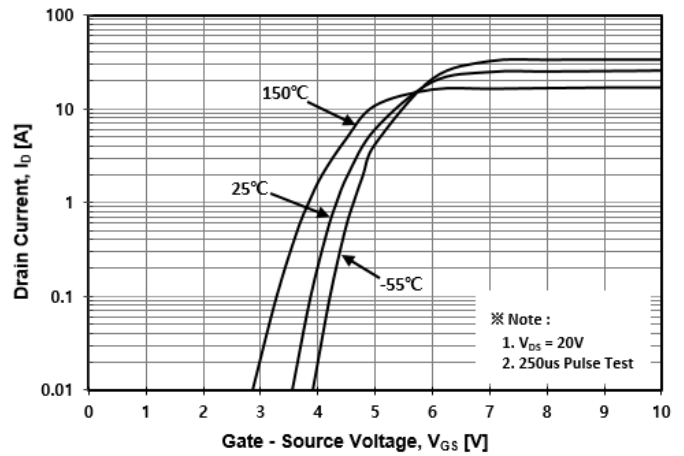


Fig. 3 $R_{DS(ON)} - I_D$

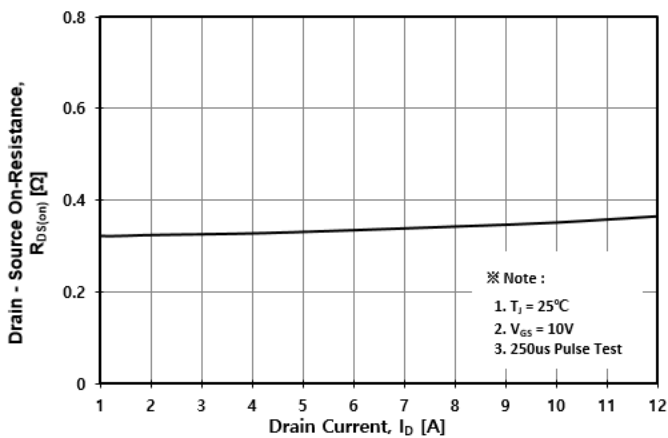


Fig. 4 $I_S - V_{SD}$

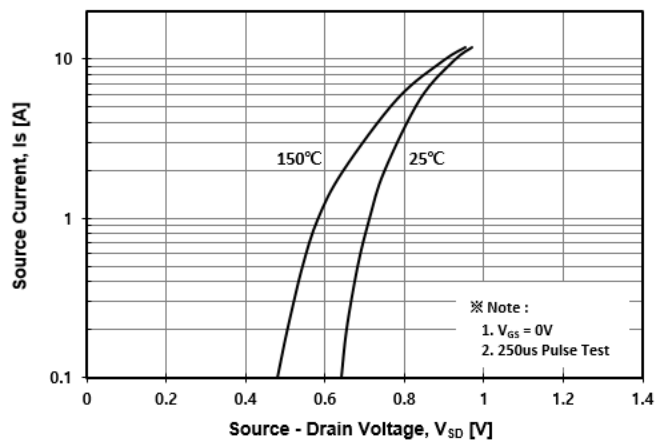


Fig. 5 Capacitance - V_{DS}

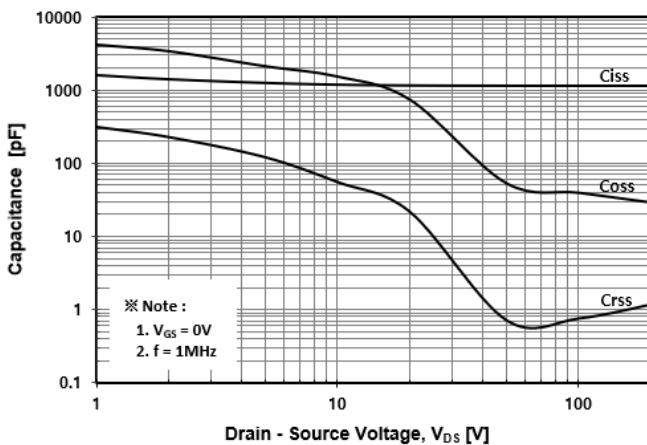
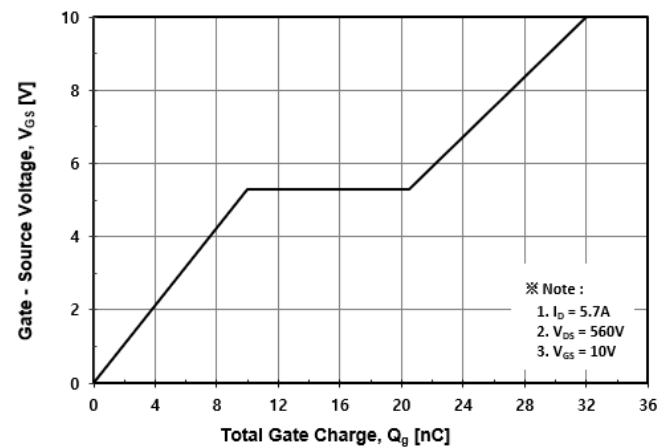


Fig. 6 $V_{GS} - Q_g$



Typical Characteristics Curve (Continue)

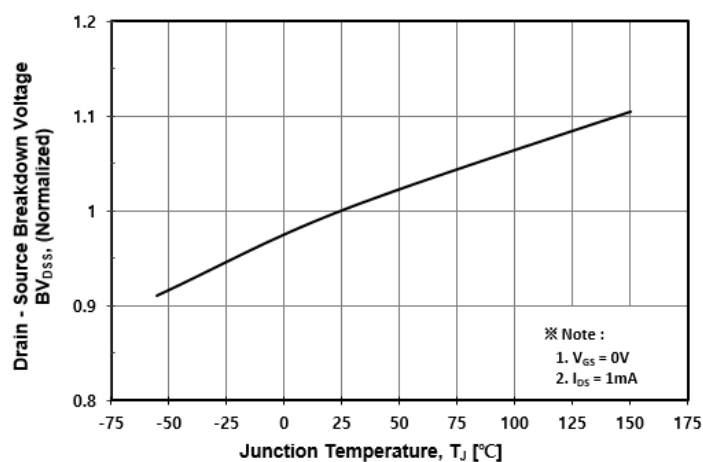
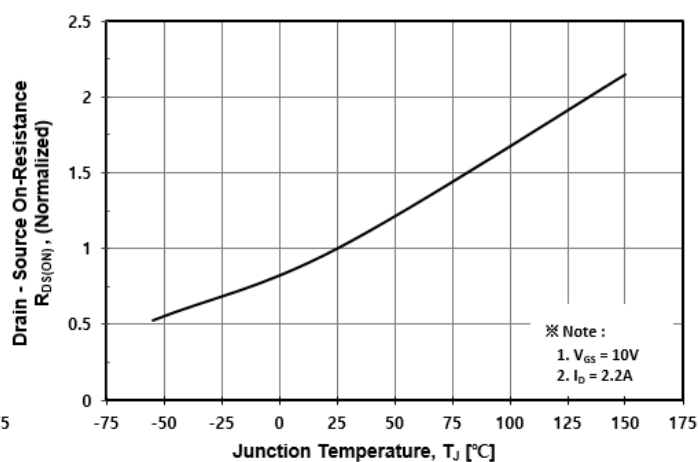
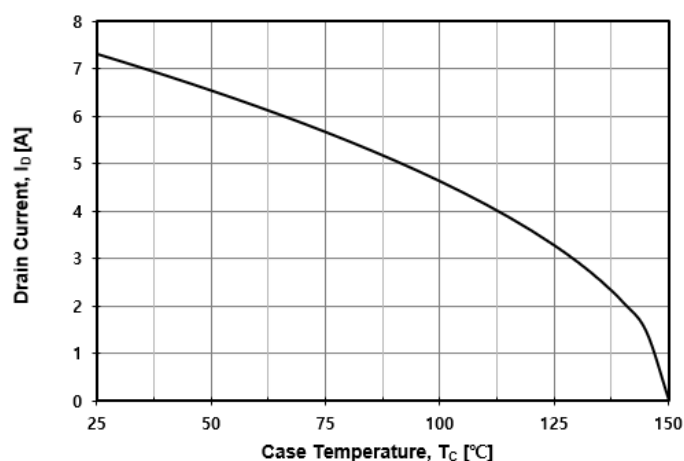
Fig. 7 $BV_{DSS} - T_J$ Fig. 8 $R_{DS(ON)} - T_J$ Fig. 9 $I_D - T_C$ 

Fig. 10 Safe Operating Area

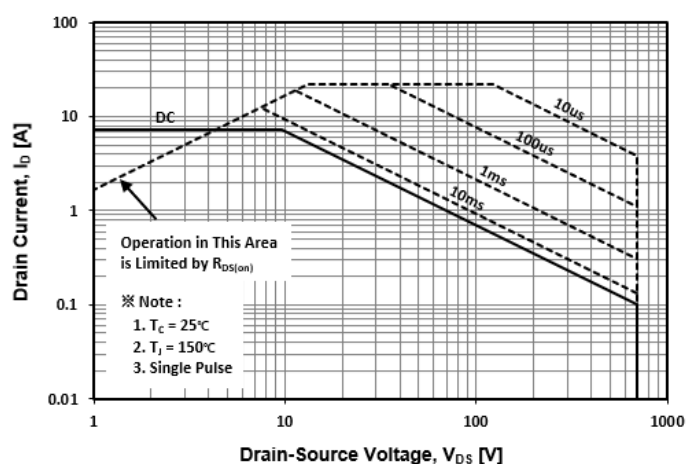


Fig. 11 Transient Thermal Impedance

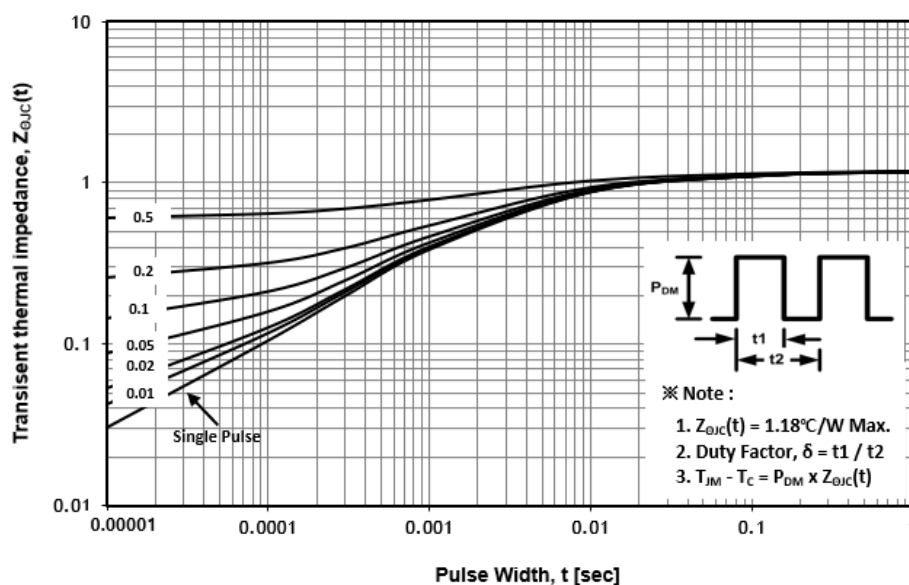


Fig. 12 Gate Charge Test Circuit & Waveform

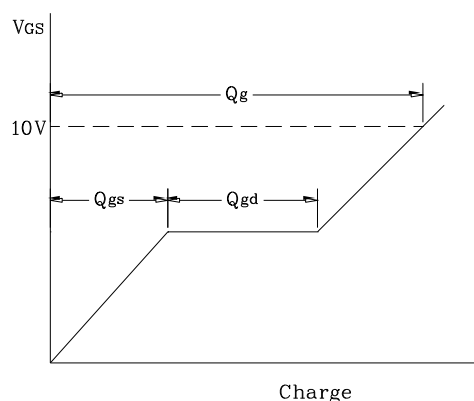


Fig. 13 Resistive Switching Test Circuit & Waveform

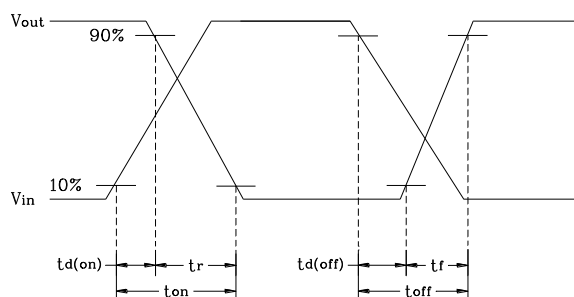
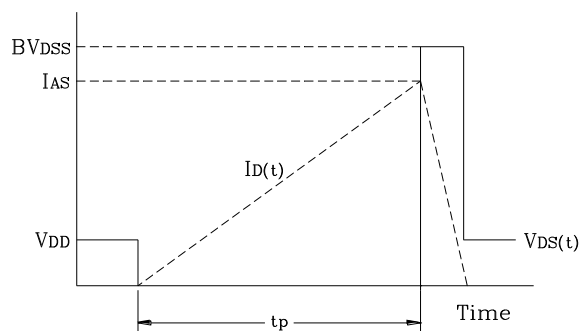
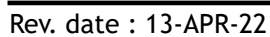
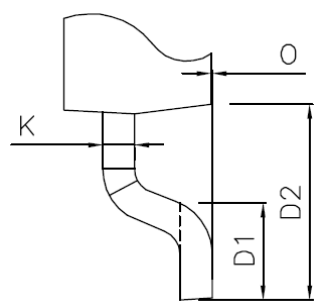
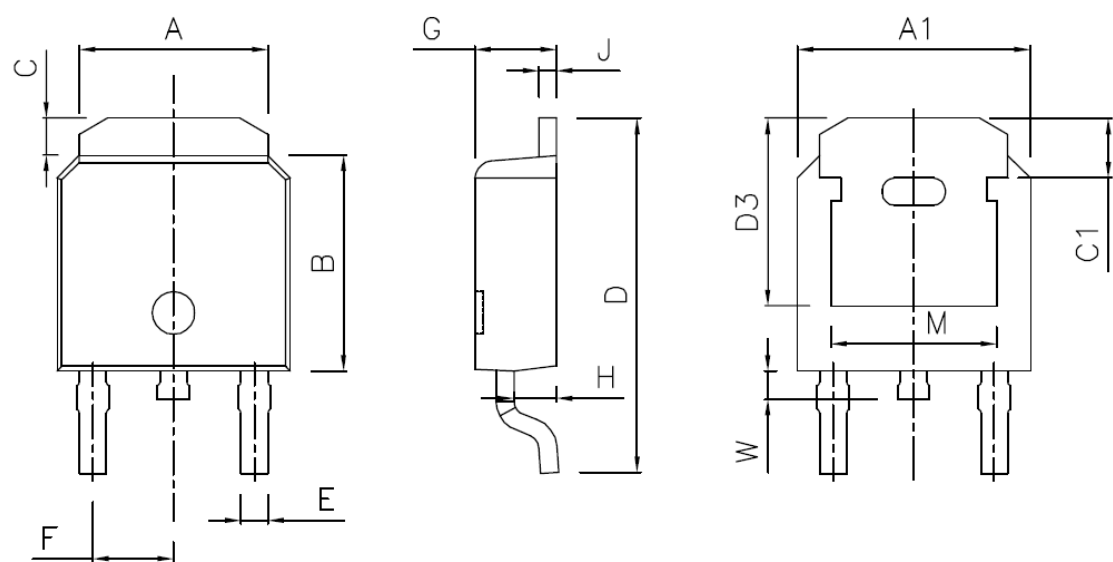


Fig. 14 E_{AS} Test Circuit & Waveform





Package Outline Dimensions



SYMBOL	MILLIMETERS		
	MIN	NOR	MAX
A	5.03	5.34	5.64
A1	6.30	6.60	6.90
B	5.70	6.00	6.30
C	0.75	1.05	1.35
C1	1.021	1.321	1.621
D	9.65	9.95	10.25
D1	1.30	1.50	1.70
D2	2.70	2.90	3.10
D3	5.00	5.30	5.60
E	0.61	0.76	0.91
F	2.13	2.28	2.43
G	2.00	2.30	2.60
H	0.76	1.06	1.36
J	0.36	0.51	0.66
K	0.37	0.52	0.67
M	4.55	4.85	5.15
O	0.00	0.07	0.17
W	0.60	0.90	1.20

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